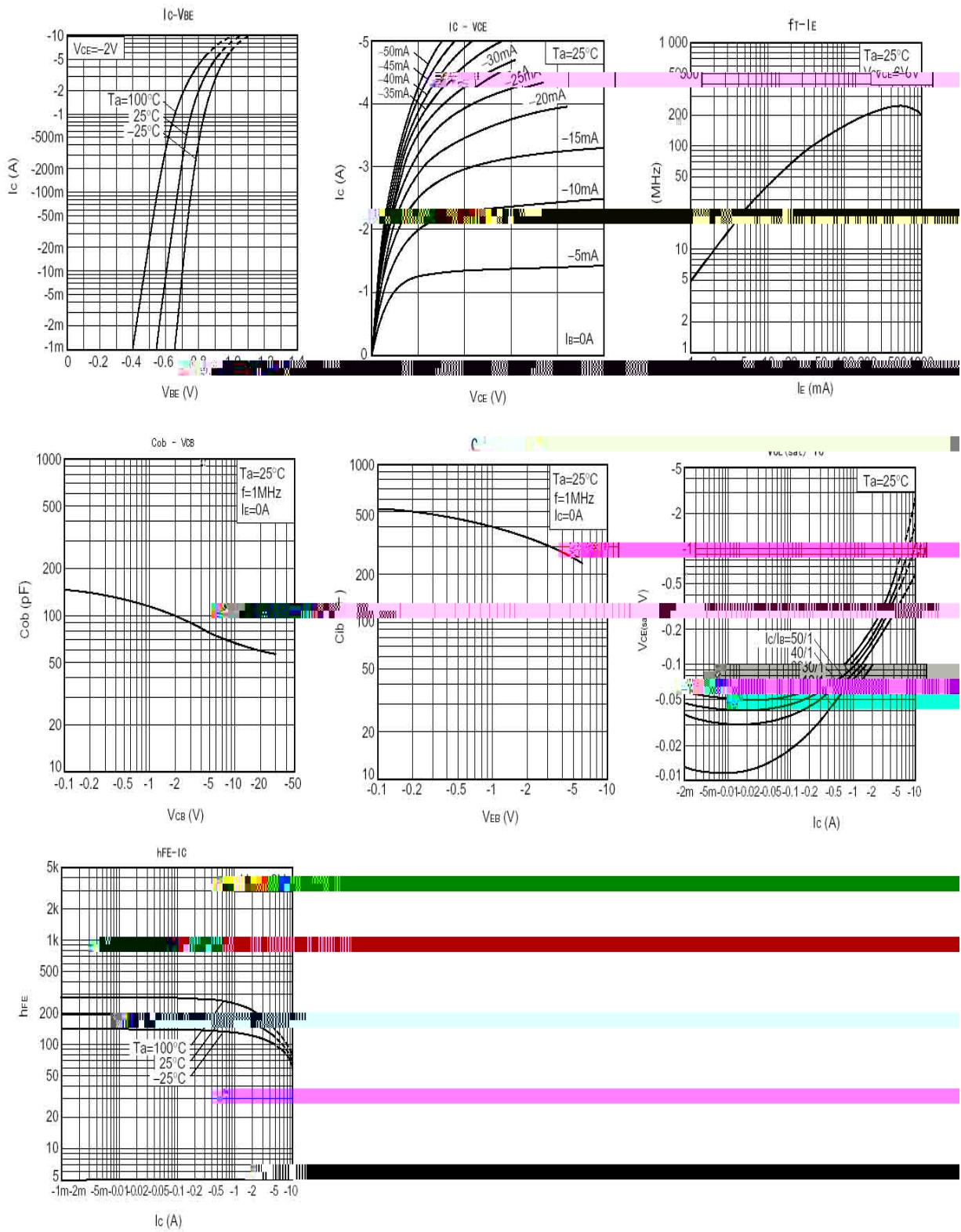
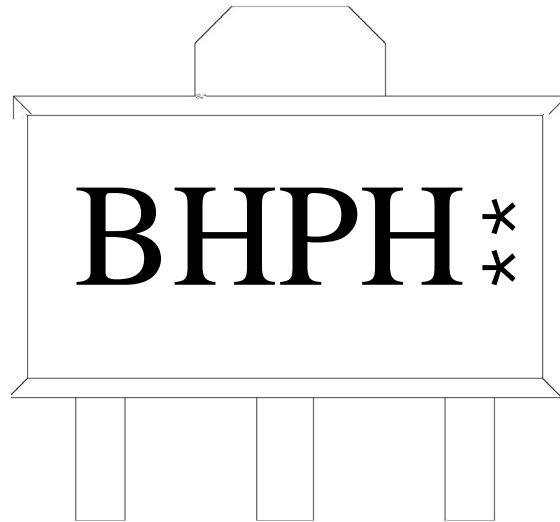


Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	-30	V
Collector to Emitter Voltage	V_{CEO}	-20	V
Emitter to Base Voltage	V_{EBO}	-6.0	V
Collector Current-Continuous	I_C	-5.0	A
Collector Base-Continuous(Pulse)	I_{CP}	-10	A
Collector Power Dissipation	P_C	0.5	W
Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55 150	

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector to Base Breakdown Voltage	V_{CBO}	$I_C=-50\mu A$ $I_E=0$	-30			V
Collector to Emitter Breakdown Voltage	V_{CEO}	$I_C=-1.0mA$ $I_B=0$	-20			V
Emitter to Base Breakdown Voltage	V_{EBO}	$I_E=-50\mu A$ $I_C=0$	-6.0			V
Collector Cut-Off Current	I_{CBO}	$V_{CB}=-20V$ $I_E=0$			-0.5	μA
Emitter Base Cut-Off Current	I_{EBO}	$V_{EB}=-5.0V$ $I_C=0$			-0.5	μA
DC Current Gain	h_{FE}	$V_{CE}=-2.0V$ $I_C=-0.5A$	82		390	
Collector to Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=-4.0A$ $I_B=-0.1A$		-0.35	-1.0	V
Transition Frequency	f_T	$V_{CE}=-6.0V$ $I_C=-50mA$ $f=30MHz$		120		MHz
Collector Output Capacitance	C_{ob}	$V_{CE}=-20V$ $I_E=0$ $f=1.0MHz$		60		pF





BH

P h_{FE}

H

**

Note:

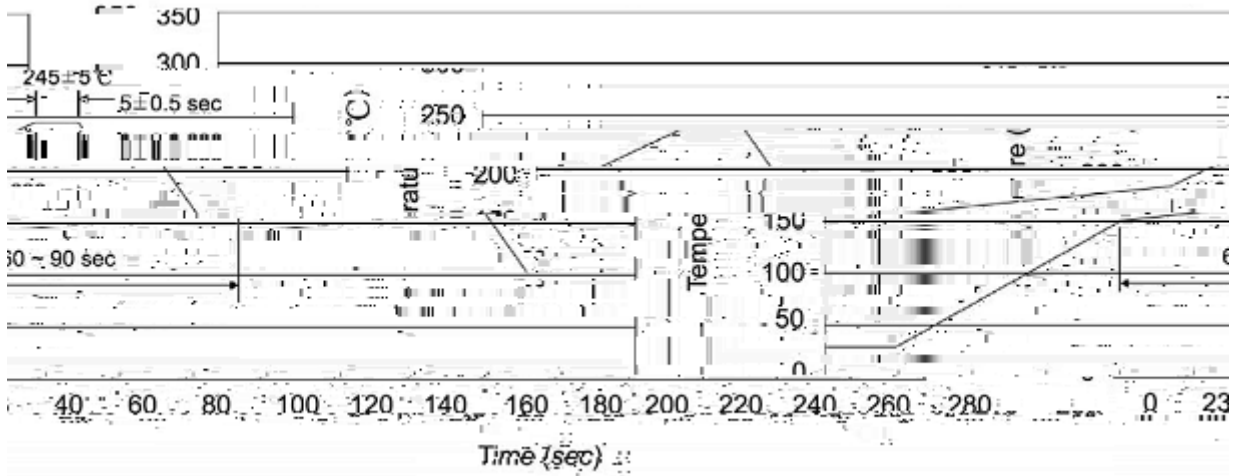
BH: Product Type.

P h_{FE} Classifications Symbol

H: Company Code.

**:

Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

- | | | | | | |
|---|-------|-----|----|-----------|---|
| 1 | 25 | 150 | 60 | 90sec; | 1.Preheating:25~150 , Time:60~90sec. |
| 2 | 245±5 | | | 5±0.5sec; | 2.Peak Temp.:245±5 , Duration:5±0.5sec. |
| 3 | | | 2 | 10 /sec. | 3. |